

MMSZ4678T1 Series

Preferred Device

Zener Voltage Regulators

500 mW SOD-123 Surface Mount

Three complete series of Zener diodes are offered in the convenient, surface mount plastic SOD-123 package. These devices provide a convenient alternative to the leadless 34-package style.

Features

- 500 mW Rating on FR-4 or FR-5 Board
- Wide Zener Reverse Voltage Range – 1.8 V to 43 V
- Package Designed for Optimal Automated Board Assembly
- Small Package Size for High Density Applications
- ESD Rating of Class 3 (>16 kV) per Human Body Model
- Pb-Free Packages are Available

Mechanical Characteristics:

CASE: Void-free, transfer-molded, thermosetting plastic case

FINISH: Corrosion resistant finish, easily solderable

MAXIMUM CASE TEMPERATURE FOR SOLDERING PURPOSES:

260°C for 10 Seconds

POLARITY: Cathode indicated by polarity band

FLAMMABILITY RATING: UL 94 V-0

MAXIMUM RATINGS

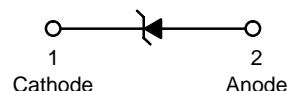
Rating	Symbol	Max	Unit
Total Power Dissipation on FR-5 Board, (Note 1) @ $T_L = 75^\circ\text{C}$ Derated above 75°C	P_D	500 6.7	mW mW/°C
Thermal Resistance, (Note 2) Junction-to-Ambient	$R_{\theta JA}$	340	°C/W
Thermal Resistance, (Note 2) Junction-to-Lead	$R_{\theta JL}$	150	°C/W
Junction and Storage Temperature Range	T_J, T_{stg}	-55 to +150	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

1. FR-5 = 3.5 X 1.5 inches, using the minimum recommended footprint.
2. Thermal Resistance measurement obtained via infrared Scan Method.

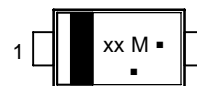


ON Semiconductor®



SOD-123
CASE 425
STYLE 1

MARKING DIAGRAM



xx = Device Code (Refer to page 3)
M = Date Code
▪ = Pb-Free Package
(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping†
MMSZ4xxxT1	SOD-123	3000/Tape & Reel
MMSZ4xxxT1G	SOD-123 (Pb-Free)	3000/Tape & Reel
MMSZ4xxxT3	SOD-123	10000/Tape & Reel
MMSZ4xxxT3G	SOD-123 (Pb-Free)	10000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

DEVICE MARKING INFORMATION

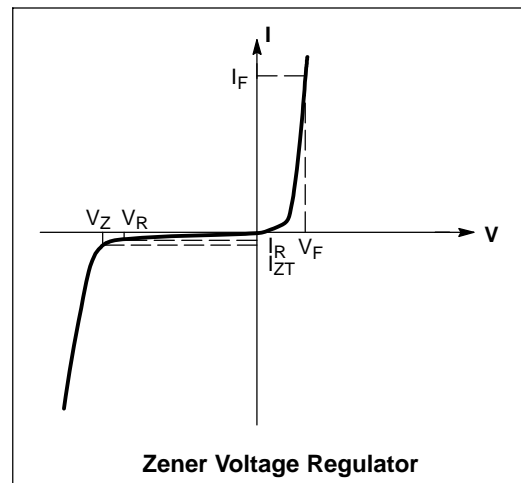
See specific marking information in the device marking column of the Electrical Characteristics table on page 3 of this data sheet.

Devices listed in **bold, italic** are ON Semiconductor **Preferred** devices. **Preferred** devices are recommended choices for future use and best overall value.

MMSZ4678T1 Series

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted, $V_F = 0.95\text{ V Max. @ } I_F = 10\text{ mA}$)

Symbol	Parameter
V_Z	Reverse Zener Voltage @ I_{ZT}
I_{ZT}	Reverse Current
I_R	Reverse Leakage Current @ V_R
V_R	Reverse Voltage
I_F	Forward Current
V_F	Forward Voltage @ I_F



MMSZ4678T1 Series

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted, $V_F = 0.9\text{ V Max.}$ @ $I_F = 10\text{ mA}$)

Device*	Device Marking	Zener Voltage (Note 3)				Leakage Current	
		V _Z (Volts)			@ I _{ZT}	I _R @ V _R	
		Min	Nom	Max	μA	μA	Volts
MMSZ4678T1, G	CC	1.71	1.8	1.89	50	7.5	1
MMSZ4679T1, G	CD	1.90	2.0	2.10	50	5	1
MMSZ4680T1, G	CE	2.09	2.2	2.31	50	4	1
MMSZ4681T1, G	CF	2.28	2.4	2.52	50	2	1
MMSZ4682T1, G	CH	2.565	2.7	2.835	50	1	1
MMSZ4683T1, G	CJ	2.85	3.0	3.15	50	0.8	1
MMSZ4684T1, G	CK	3.13	3.3	3.47	50	7.5	1.5
MMSZ4685T1, G	CM	3.42	3.6	3.78	50	7.5	2
MMSZ4686T1, G	CN	3.70	3.9	4.10	50	5	2
MMSZ4687T1, G	CP	4.09	4.3	4.52	50	4	2
MMSZ4688T1, G	CT	4.47	4.7	4.94	50	10	3
MMSZ4689T1, G	CU	4.85	5.1	5.36	50	10	3
MMSZ4690T1, G	CV	5.32	5.6	5.88	50	10	4
MMSZ4691T1, G	CA	5.89	6.2	6.51	50	10	5
MMSZ4692T1, G	CX	6.46	6.8	7.14	50	10	5.1
MMSZ4693T1, G	CY	7.13	7.5	7.88	50	10	5.7
MMSZ4694T1, G	CZ	7.79	8.2	8.61	50	1	6.2
MMSZ4695T1, G	DC	8.27	8.7	9.14	50	1	6.6
MMSZ4696T1, G	DD	8.65	9.1	9.56	50	1	6.9
MMSZ4697T1, G	DE	9.50	10	10.50	50	1	7.6
MMSZ4698T1, G	DF	10.45	11	11.55	50	0.05	8.4
MMSZ4699T1, G	DH	11.40	12	12.60	50	0.05	9.1
MMSZ4700T1, G	DJ	12.35	13	13.65	50	0.05	9.8
MMSZ4701T1, G	DK	13.30	14	14.70	50	0.05	10.6
MMSZ4702T1, G	DM	14.25	15	15.75	50	0.05	11.4
MMSZ4703T1, G †	DN	15.20	16	16.80	50	0.05	12.1
MMSZ4704T1, G	DP	16.15	17	17.85	50	0.05	12.9
MMSZ4705T1, G	DT	17.10	18	18.90	50	0.05	13.6
MMSZ4706T1, G	DU	18.05	19	19.95	50	0.05	14.4
MMSZ4707T1, G	DV	19.00	20	21.00	50	0.01	15.2
MMSZ4708T1, G	DA	20.90	22	23.10	50	0.01	16.7
MMSZ4709T1, G	DX	22.80	24	25.20	50	0.01	18.2
MMSZ4710T1, G	DY	23.75	25	26.25	50	0.01	19.0
MMSZ4711T1, G †	EA	25.65	27	28.35	50	0.01	20.4
MMSZ4712T1	EC	26.60	28	29.40	50	0.01	21.2
MMSZ4713T1, G	ED	28.50	30	31.50	50	0.01	22.8
MMSZ4714T1, G	EE	31.35	33	34.65	50	0.01	25.0
MMSZ4715T1, G	EF	34.20	36	37.80	50	0.01	27.3
MMSZ4716T1, G	EH	37.05	39	40.95	50	0.01	29.6
MMSZ4717T1, G	EJ	40.85	43	45.15	50	0.01	32.6

3. Nominal Zener voltage is measured with the device junction in thermal equilibrium at $T_L = 30^\circ\text{C} \pm 1^\circ\text{C}$.

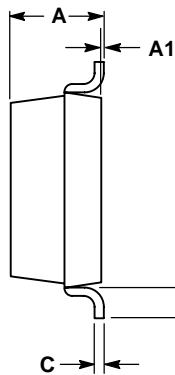
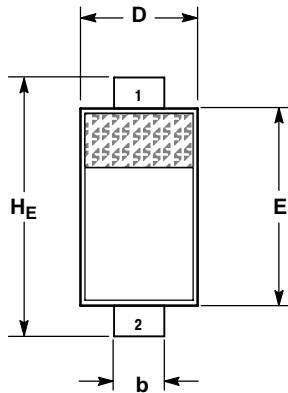
*The "G" suffix indicates Pb-Free package available.

†MMSZ4703 and MMSZ4711 Not Available in 10,000/Tape & Reel

MMSZ4678T1 Series

PACKAGE DIMENSIONS

SOD-123
CASE 425-04
ISSUE E



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

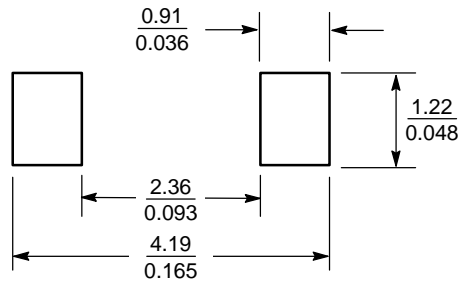
2. CONTROLLING DIMENSION: INCH.

DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.94	1.17	1.35	0.037	0.046	0.053
A1	0.00	0.05	0.10	0.000	0.002	0.004
b	0.51	0.61	0.71	0.020	0.024	0.028
c	---	---	0.15	---	---	0.006
D	1.40	1.60	1.80	0.055	0.063	0.071
E	2.54	2.69	2.84	0.100	0.106	0.112
H_E	3.56	3.68	3.86	0.140	0.145	0.152
L	0.25	---	---	0.010	---	---

STYLE 1:

PIN 1. CATHODE
2. ANODE

SOLDERING FOOTPRINT*



SCALE 10:1 $\left(\frac{\text{mm}}{\text{inches}} \right)$

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.